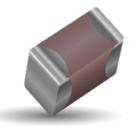
X5R Dielectric General Specifications

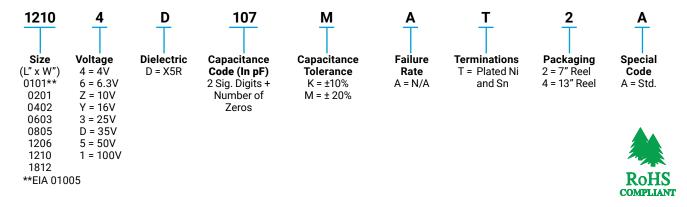




GENERAL DESCRIPTION

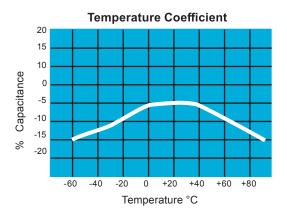
- · General Purpose Dielectric for Ceramic Capacitors
- EIA Class II Dielectric
- Temperature variation of capacitance is within ±15% from -55°C to +85°C
- Well suited for decoupling and filtering applications
- Available in High Capacitance values (up to 100µF)

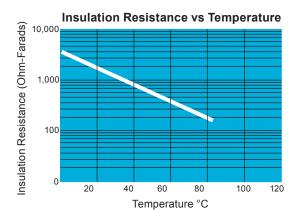
PART NUMBER (SEE PAGE 4 FOR COMPLETE PART NUMBER EXPLANATION)



NOTE: Contact factory for availability of Tolerance Options for Specific Part Numbers. Contact factory for non-specified capacitance values.

TYPICAL ELECTRICAL CHARACTERISTICS





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TDS-SMDMLCC-0014 | Rev 1

X5R Dielectric Specifications and Test Methods



Parame	ter/Test	X5R Specification Limits	Measuring Conditions						
Operating Tem		-55°C to +85°C	Temperature Cycle Chamber						
Capac	itance	Within specified tolerance	_						
Dissipati	on Factor	≤ 2.5% for ≥ 50V DC rating ≤ 12.5% for 25V, 35V DC rating ≤ 12.5% Max. for 16V DC rating and lower Contact Factory for DF by PN	Freq.: 1.0 kHz ± 10% Voltage: 1.0Vrms ± .2V For Cap > 10 μF, 0.5Vrms @ 120Hz						
Insulation	Resistance	10,000MΩ or 500MΩ - μF, whichever is less	Charge device with rated voltage for 120 ± 5 secs @ room temp/humidity						
Dielectric	: Strength	No breakdown or visual defects	Charge device with 250% of rated voltage for 1-5 seconds, w/charge and discharge current limited to 50 mA (max)						
	Appearance	No defects	Deflectior	n: 2mm					
Resistance to	Capacitance Variation	≤ ±12%	Test Time: 30						
Flexure Stresses	Dissipation Factor	Meets Initial Values (As Above)							
	Insulation Resistance	≥ Initial Value x 0.3	90 mm						
Solder	rability	≥ 95% of each terminal should be covered with fresh solder	Dip device in eutectic solo ± 0.5 sec						
	Appearance	No defects, <25% leaching of either end terminal							
	Capacitance Variation	≤ ±7.5%	1						
Resistance to Solder Heat	Dissipation Factor	Meets Initial Values (As Above)	Dip device in eutectic solder at 260°C for 60seconds. Store at room temperature for 24 ±						
•••••	Insulation Resistance	Meets Initial Values (As Above)	2hours before measuring	2hours before measuring electrical properties.					
	Dielectric Strength	Meets Initial Values (As Above)							
	Appearance	No visual defects	Step 1: -55°C ± 2°	30 ± 3 minutes					
	Capacitance Variation	≤ ±7.5%	Step 2: Room Temp	≤ 3 minutes					
Thermal Shock	Dissipation Factor	Meets Initial Values (As Above)	Step 3: +85°C ± 2°	30 ± 3 minutes					
	Insulation Resistance	Meets Initial Values (As Above)	Step 4: Room Temp	≤ 3 minutes					
	Dielectric Strength	Meets Initial Values (As Above)		5 cycles and measure after 24 ± 2 ours at room temperature					
	Appearance	No visual defects	 Charge device with 1.5X rated voltage in test chamber set at 85°C ± 2°C for 1000 hours (+48, -0). Note: Contact factory for *optional specification part numbers that are tested at < 1.5X rated voltage. Remove from test chamber and stabilize at room temperature for 24 ± 2 hours 						
	Capacitance Variation	≤ ±12.5%							
Load Life	Dissipation Factor	≤ Initial Value x 2.0 (See Above)							
	Insulation Resistance	≥ Initial Value x 0.3 (See Above)							
	Dielectric Strength	Meets Initial Values (As Above)							
	Appearance	No visual defects							
	Capacitance Variation	≤ ±12.5%	Store in a test chamber se 5% relative humidity for 10						
Load Humidity	Dissipation Factor	≤ Initial Value x 2.0 (See Above)	Remove from chamber and stabilize at room temperature and humidity for 24 ± 2 hours before measuring.						
inaniary	Insulation Resistance	≥ Initial Value x 0.3 (See Above)							
	Dielectric	Meets Initial Values (As Above)							

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TDS-SMDMLCC-0014 | Rev 1



PREFERRED SIZES ARE SHADED

Case Size 0101*				0201					0402					0603							0805							
Soldering		Reflow Only Reflow Only					Reflow/Wave					Reflow/Wfeve						Reflow/Wfeve										
Packaging		Paper/Er				II Pape					All F				All Paper							Paper/Embossed						
(L) Length	mm (in.)	$\begin{array}{ c c c c c c c c c c c c c c c c c c c$							1.00 ± 0.20 (0.040 ± 0.008)						1.60 ± 0.20 (0.063 ± 0.008)							2.01 ± 0.20 (0.079 ± 0.008)						
W) Width	mm (in.)	0.20 ± 0.02 0.30 ± 0.09 (0.008 ± 0.0008) (0.011 ± 0.004)							$\begin{array}{c} 0.50 \pm 0.20 \\ (0.020 \pm 0.008) \end{array}$						0.80 ± 0.20							1.25 ± 0.20						
	<u> </u>	0.10						0.25 ± 0.10					(0.031 ± 0.008) 0.35 ± 0.15						(0.049 ± 0.008) 0.50 ± 0.25									
(t) Terminal	mm (in.)	(0.004 ±		(0.006 ± 0.002)				0.25 ± 0.10 (0.010 ± 0.004)											0.50 ± 0.25 (0.020 ± 0.010)									
Voltage:	(11.)	6.3	10	(0.006 ± 0.002) 4 6.3 10 16 25											(0.014 ± 0.006) 4 6.3 10 16 25 35 50													
Cap (pF) 100	101	0.3	B	4	0.5	10	10	 A	4	0.3	10	10	23	30	4	0.3	10	10	23	35	30	4	0.3	10	10	23	35	- 30
150 (pr)	151		B					A																				
220	221		B					A						С														
			B											C C													<u> </u>	
330	331		-					A						-														
470	471		B					A						С														<u> </u>
680	681		В					A						С														
1000	102	_	В				A	A						С														\square
1500	152	В	В				A	A						С														
2200	222	В	В			A	A	A						С														
3300	332	В	В			A	A	A						С														
4700	472	В	В			A	A	A					С								G							
6800	682	В	В			A	A	Α					С								G							
Cap (µF) 0.01	103	В	В			A	A	Α					С						G	G	G							
0.015	150	В											С						G	G	G							
0.022	223	В			A	A	A	A				С	С						G	G	G							N
0.033	333	В										С							G	G	G							N
0.047	473	В			A	A	A	A				С	С						G	G	G							N
0.068	689	В										С							G		G							N
0.1	104	В			Α	A	Α	Α			С	С	С	С					G	G	G					N	N	N
0.15	154																		G							N	N	
0.22	224	В		Α	A	A				C	С	С	С	С				G	G							Ν	N	N
0.33	334																	G	G							N		
0.47	474	В		Α	A				С	C	С	С	С	E				G	J							N	P	P
0.68	684																	G								N		
1.0	105			Α	A	С	С		С	С	С	С	С		G	G	G	G	J	G	G				Ν	N	Р	Р
1.5	155																											
2.2	225			С	С	С			С	C	С	С	С		G	G	J	J	J	K	K			Ν	N	Р	Р	Р
3.3	335														J	J	J	J					Ν	Ν				
4.7	475			С	С				E	E	E	E			J	J	J	G	K			N	Р	J	N	N	Р	Р
10	106								E	E	E				К	J	K	K	K			Р	Р	Р	Р	Р		
22	226								E	G					K	K	K					Р	Р	Р	Р	Р		
47	476														K	K						Р	Р	Р				
100	107																											
Voltage:		6.3	10	4	6.3	10	16	25	4	6.3	10	16	25	50	4	6.3	10	16	25	35	50	4	6.3	10	16	25	35	50
Case Size		01	01*			0201					04	02						0603							0805			

Letter	A	В	С	E	G	J	К	М	N	Р	Q	Х	Y	Z		
Max. Thickness	0.33 (0.013)	0.22 (0.009)	0.56 (0.022)	0.71 (0.028)	0.90 (0.035)	0.94 (0.037)	1.02 (0.040)	1.27 (0.050)	1.40 (0.055)	1.52 (0.060)	1.78 (0.070)	2.29 (0.090)	2.54 (0.100)	2.79 (0.110)		
	PAPER							EMBOSSED								

PAPER and EMBOSSED available for 01005

NOTE: Contact factory for non-specified capacitance values *EIA 01005

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TDS-SMDMLCC-0014 | Rev 1